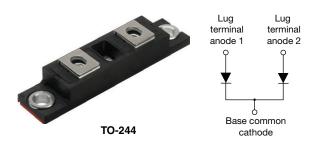
**Vishay Semiconductors** 

# **HEXFRED<sup>®</sup>** Ultrafast Soft Recovery Diode, 240 A



240 A

400 V

197 A at 100 °C

TO-244

Two diodes common cathode

**PRIMARY CHARACTERISTICS** 

I<sub>F(AV)</sub>

 $V_R$ 

I<sub>F(DC)</sub> at T<sub>C</sub>

Package

Circuit configuration

www.vishay.com

#### **FEATURES**

- Very low Q<sub>rr</sub> and t<sub>rr</sub>
- UL approved file E222165
- · Designed and qualified for industrial level



• Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **BENEFITS**

- Reduced RFI and EMI
- Reduced snubbing

#### **DESCRIPTION / APPLICATIONS**

HEXFRED® diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and dl<sub>F</sub>/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Cathode to anode voltage	VR		400	V	
Continuous forward current	l <sub>F</sub>	T <sub>C</sub> = 25 °C	395		
		T <sub>C</sub> = 100 °C	197	А	
Single pulse forward current	I <sub>FSM</sub>	Limited by junction temperature	900		
Non-repetitive avalanche energy	E <sub>AS</sub>	L = 100 $\mu$ H, duty cycle limited by maximum T <sub>J</sub>	1.4	mJ	
Maximum power dissipation	P <sub>D</sub>	T <sub>C</sub> = 25 °C	658	W	
		T <sub>C</sub> = 100 °C	263	vv	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +150	°C	

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V <sub>BR</sub>	I <sub>R</sub> = 100 μA		400	-	-	
Maximum forward voltage	V <sub>FM</sub>	I <sub>F</sub> = 120 A	See fig. 1	-	1.1	1.47	V
		I <sub>F</sub> = 240 A		-	1.3	1.5	
		I <sub>F</sub> = 120 A, T <sub>J</sub> = 125 °C		-	1.0	1.2	
Maximum reverse leakage current	I <sub>RM</sub>	T <sub>J</sub> = 125 °C, V <sub>R</sub> = 400 V	See fig. 2	-	660	5000	μA
Junction capacitance	CT	V <sub>R</sub> = 200 V	See fig. 3	-	280	380	pF
Series inductance	L <sub>S</sub>	From top of terminal hole to mounting plane		-	6.0	-	nH

Revision: 11-Jan-17 1 For technical questions within your region: DiodesAmericas@vishav.com, DiodesAsia@vishav.com, DiodesEurope@vishav.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000



www.vishay.com

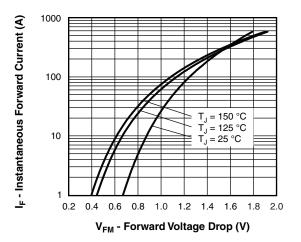
### **Vishay Semiconductors**

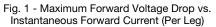
<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Reverse recovery time See fig. 5	t <sub>rr</sub>	$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	50	-	
		T <sub>J</sub> = 25 °C	I <sub>F</sub> = 140 A dI <sub>F</sub> /dt = 200 A/μs V <sub>R</sub> = 200 V	-	77	120	ns
		T <sub>J</sub> = 125 °C		-	290	440	
Peak recovery current See fig. 6	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	7.5	14	А
		T <sub>J</sub> = 125 °C		-	16	30	
Reverse recovery charge See fig. 7	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	290	780	nC
		T <sub>J</sub> = 125 °C		-	2300	6300	
Peak rate of recovery current See fig. 8	dl <sub>(rec)M</sub> /dt	T <sub>J</sub> = 25 °C		-	320	-	A/µs
		T <sub>J</sub> = 125 °C		-	270	-	

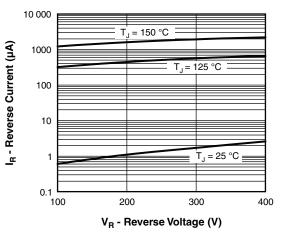
THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS	
Maximum junction and storage temperature range		T <sub>J</sub> , T <sub>Stg</sub>	- 55	-	150	°C	
Thermal resistance, junction to case	per leg	– R <sub>thJC</sub>	-	-	0.19	°C/W	
	per module		-	-	0.095		
Typical thermal resistance, case to heatsink		R <sub>thCS</sub>	-	0.10	-		
Weight			-	68	-	g	
Weight			-	2.4	-	oz.	
Mounting torgue <sup>(1)</sup>			30 (3.4)	-	40 (4.6)	lbf ⋅ in (N ⋅ m)	
Mounting torque (%	center hole		12 (1.4)	-	18 (2.1)		
Terminal torque			30 (3.4)	-	40 (4.6)	()	
Vertical pull 2" lever pull			-	-	80	lbf ⋅ in	
			-	-	35	חויוטו	

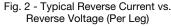
#### Note

(1) Mounting surface must be smooth, flat, free of burrs or other protrusions. Apply a thin even film or thermal grease to mounting surface. Gradually tighten each mounting bolt in 5 to 10 lbf · in steps until desired or maximum torque limits are reached









For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



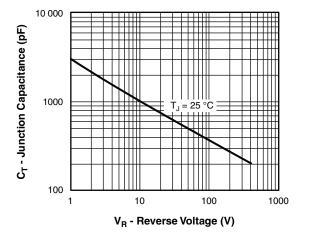


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

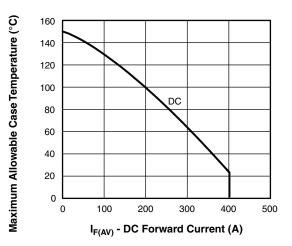


Fig. 4 - Maximum Allowable Case Temperature vs. DC Forward Current (Per Leg)

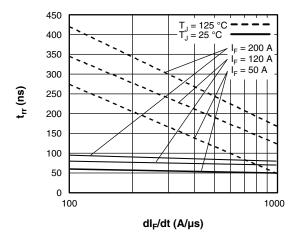


Fig. 5 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt (Per Leg)

**Vishay Semiconductors** 

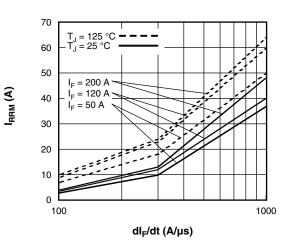
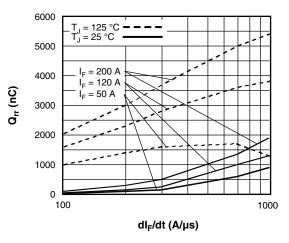
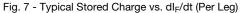


Fig. 6 - Typical Recovery Current vs. dl<sub>F</sub>/dt (Per Leg)





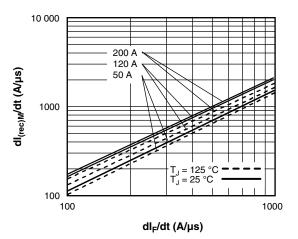


Fig. 8 - Typical dI(rec)M/dt vs. dIF/dt (Per Leg)

Revision: 11-Jan-17

3

Document Number: 94063

For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

#### VS-HFA240NJ40CPbF www.vishay.com **Vishay Semiconductors** 1 Z<sub>thJC</sub> - Thermal Response 0.1 D = 0.50D = 0.33 0.01 <sup>►</sup>D = 0.25 $\sum_{n=0.17}^{\infty} D = 0.17$ <sup>-</sup>D = 0.08 Single pulse (thermal response) 1 1 1 1 1 1 1 0.001 0.00001 0.001 0.0001 0.01 0.1 1 10 t<sub>1</sub> - Rectangular Pulse Duration (s)

Fig. 9 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics (Per Leg)

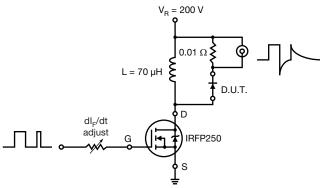
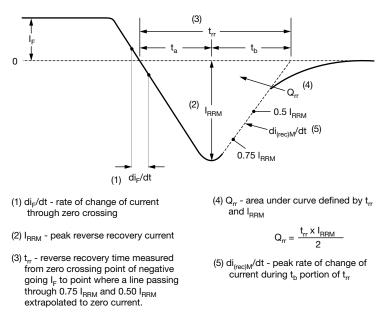
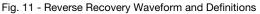


Fig. 10 - - Reverse Recovery Parameter Test Circuit





# Revision: 11-Jan-17 4 Document Number: 94063 For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com DiodesEurope@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



**Vishay Semiconductors** 

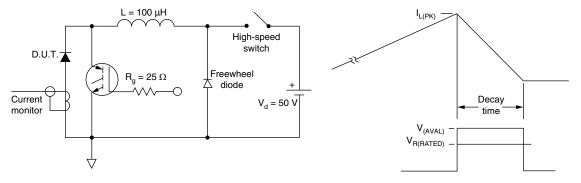
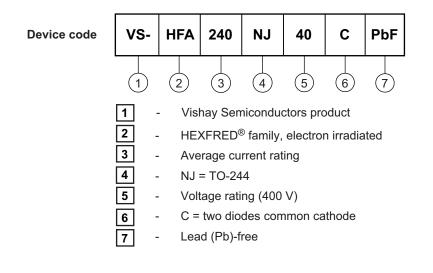


Fig. 12 - Avalanche Test Circuit and Waveforms

#### **ORDERING INFORMATION TABLE**



LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95021				

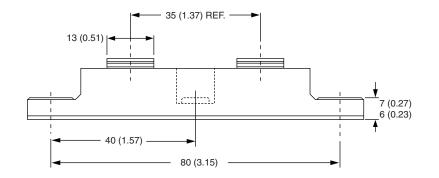


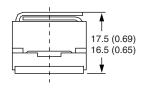


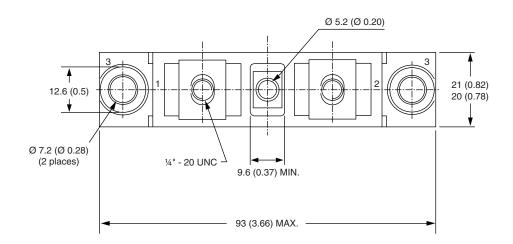
**Vishay Semiconductors** 

**TO-244** 

#### **DIMENSIONS** in millimeters (inches)









Vishay

# Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.